

Title (en)
ASSEMBLY FOR ELECTRICAL/ELECTRONIC COMPONENTS

Title (de)
MONTAGE ELEKTRISCHER/ELEKTRONISCHER KOMPONENTEN

Title (fr)
MONTAGE DESTINEE A DES ELEMENTS ELECTRIQUES/ELECTRONIQUES

Publication
EP 1254481 A2 20021106 (EN)

Application
EP 00956698 A 20000831

Priority

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- GB 9921307 A 19990910

Abstract (en)
[origin: GB2354116A] An assembly for electrical/electronic components 10 has one or more component carriers 6 arranged to mate with a receiving station 3 provided in a heatsink body 2 and be in thermal communication contact with the heatsink body. Electrical or electronic components 10 are carried by the component carrier and an electrical contact arrangement 11,13 for a respective component/component carrier sub-assembly, is configured for connection to an electric/electronic circuit 14. The circuit 14 may be operable in different modes depending on the nature and/or arrangement of the components 10.

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H05K 7/20 (2006.01)

CPC (source: EP)
H01L 23/367 (2013.01); **H01L 23/4006** (2013.01); **H05K 7/20509** (2013.01); **H01L 2924/0002** (2013.01)

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